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# SH7280 Group

## Reception of Serial Data by the SCIF in Asynchronous Mode

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### Introduction

This application note describes reception of serial data by using asynchronous transfer function of the serial communications interface with FIFO (SCIF). This application note is a summary for quick reference of information required in the design of user software.

### Target Device

SH7285

### Contents

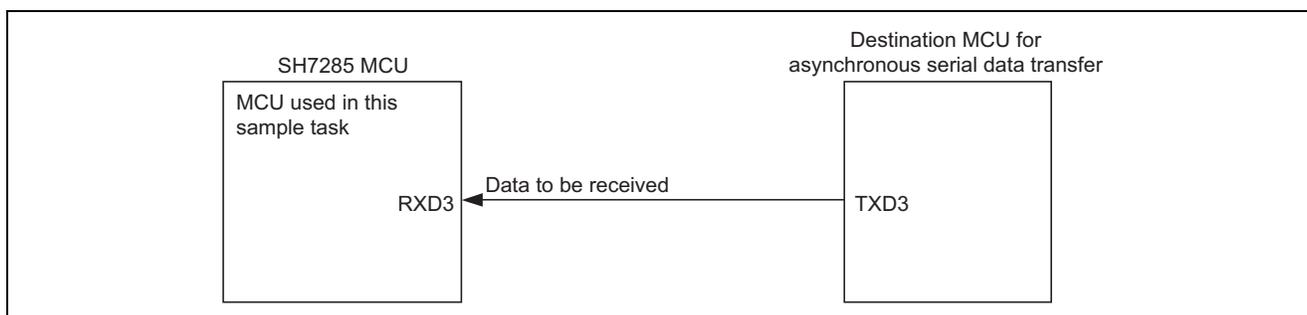
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## 1. Preface

### 1.1 Specifications

This sample application employs the clock-synchronous serial transfer function of the serial communications interface with FIFO (SCIF) to perform data reception. Figure 1 shows an example of connection for reception by the SCIF in clock-synchronous mode.

- SCIF3 is used.
- The communications format has a fixed 8-bit data length, 1 stop bit, and no parity bit.
- The reception interrupt is used to conduct unidirectional communications via SCIF3. That is, the data-transfer controller (DTC) is activated by the receive-data-full interrupt.
- Once 32 bytes of data have been received, operation for reception is halted.



**Figure 1 Connection Example for Reception by the SCIF in Asynchronous Mode**

### 1.2 Module Used

Serial communications interface with FIFO (SCIF3)

### 1.3 Applicable Conditions

MCU	SH7285
Operating frequency	Internal clock: 100 MHz Bus clock: 50 MHz Peripheral clock: 50 MHz
C compiler	SuperH RISC engine Family C/C++ Compiler Package Ver.9.1.1 (from Renesas Technology Corp.)

## 2. Description of the Sample Application

This sample application employs the receive-FIFO-data-full interrupt (RXI) source of the serial communications interface with FIFO (SCIF) to receive serial data in asynchronous mode.

### 2.1 Summary of MCU Module Used

In asynchronous mode, each received character begins with a start bit and ends with a stop bit. Serial communication is synchronized in character units. The receiving section has a 16-stage FIFO buffered structure so that data can be read or written during reception, which enables high-speed continuous data transfer.

In asynchronous serial communications, the communication line is normally held in the mark (high) state. The SCIF monitors the line and starts serial communications when the line goes to the space (low) state, indicating a start bit.

One serial character consists of a start bit (low), data (LSB first), parity bit (high or low), and stop bit (high), in this order.

For details on the SCIF, please refer to the section on serial communications interface with FIFO in the *SH7280 Group Hardware Manual (REJ09B0393)*.

Table 1 gives an overview of serial communications in asynchronous mode. Figure 2 shows a block diagram of the SCIF.

**Table 1 Overview of Serial Data Communications in Asynchronous Mode**

Item	Description
Number of interfaces	1 (SCIF3)
Clock sources	For internal clock: $P\phi$ , $P\phi/4$ , $P\phi/16$ , $P\phi/64$ ( $P\phi$ : peripheral clock) For external clock: input clock on the SCK3 pin
Data format	Transfer data length: Selectable from 7 or 8 bits Order: LSB first and MSB first are selectable
Baud rate	For internal clock: from 110 bps ( $P\phi = 50$ MHz) For external clock: up to 781,250 bps ( $P\phi = 50$ MHz, external input clock of 12.5000 MHz)
Error detection	Framing, parity and overrun errors Breaks can also be detected.
Interrupt requests	Receive-FIFO-data-full interrupt (RXI) Break interrupt (BRI) Receive error interrupt (ERI)
Clock sources	Internal and external clocks are selectable <ul style="list-style-type: none"> <li>• Internal clock When the internal clock has been selected, the SCIF operates using the clock from the baud-rate generator and a clock signal at 16 times the frequency of the bit rate can be output.</li> <li>• External clock When the external clock has been selected, input of a clock signal at 16 times the frequency of the bit rate is required, not using the on-chip baud rate generator.</li> </ul>

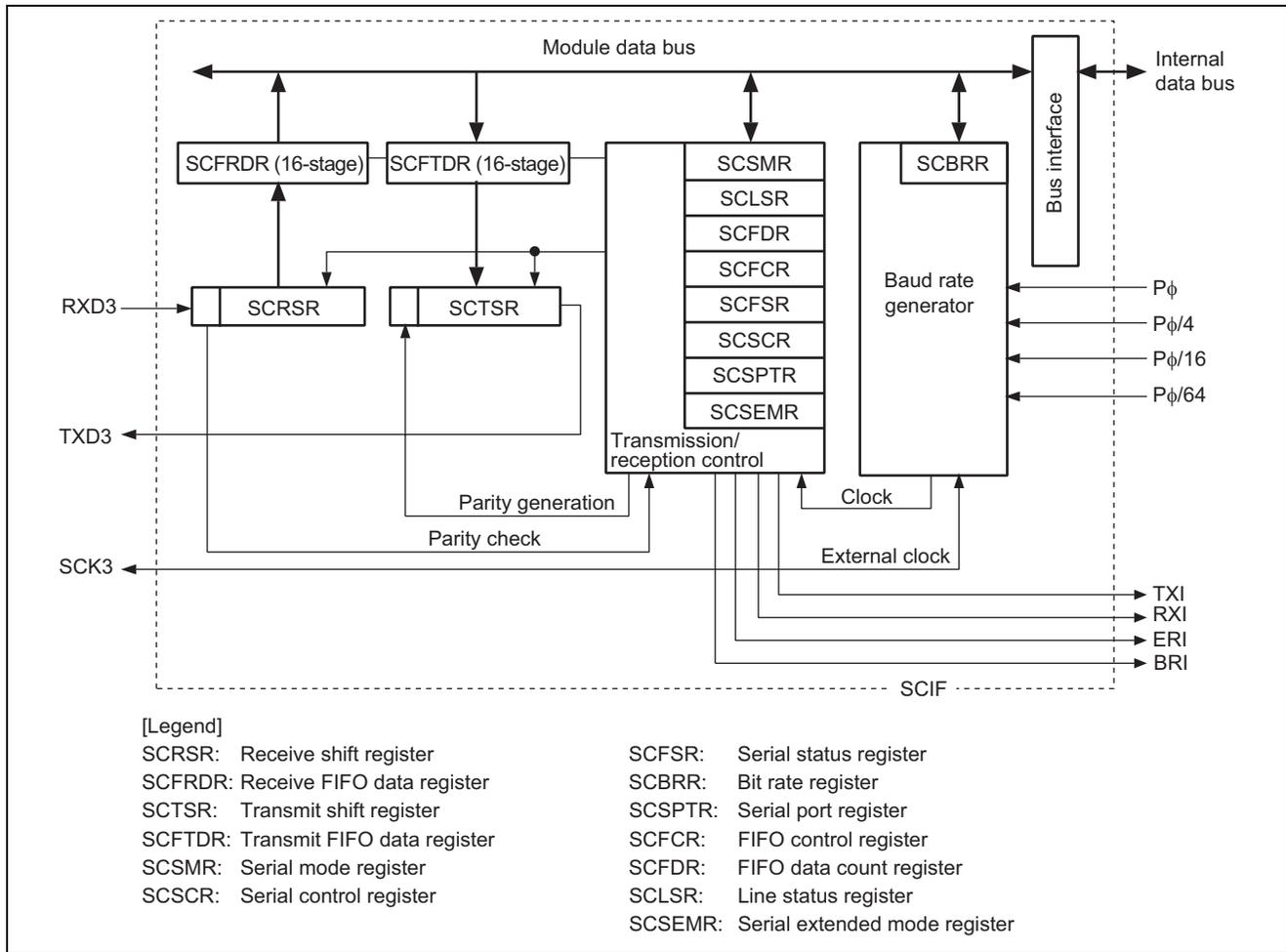


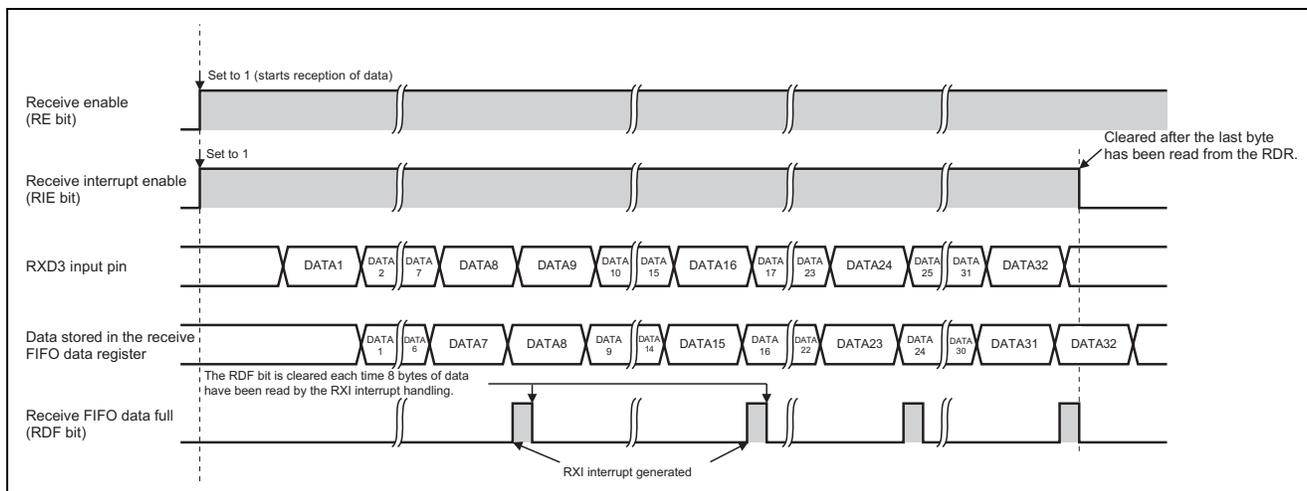
Figure 2 Block Diagram of the SCIF

### 2.2 Description of the Sample Program

Table 2 gives the settings for SCIF communications function of this sample program, and figure 3 shows the operations in data reception.

**Table 2 Settings for Communications Function of the Sample Program**

Item	Description
Module	SCIF3
Communications mode	Asynchronous mode
Interrupts	Receive-FIFO-data-full interrupt (RXI) Break interrupt (BRI)
Transfer rate	38,400 bps
Number of data to be received	32 bytes
Data length	8-bit data
Stop bit	1 stop bit
Parity	None
Bit order	LSB-first
FIFO data trigger number	Receive FIFO data trigger: 8



**Figure 3 Operations for Data Reception**

### 2.3 Procedure for Setting Module Used

This section describes the procedure for setting up SCIF3 for asynchronous mode operation.

Figure 4 shows the flow of processing by the sample program, figure 5 shows the flow of settings for release from module-standby mode, figure 6 shows the flow for initialization of data reception in asynchronous mode, and figure 7 shows the flow for setting up the pin function controller. Furthermore, figure 8 shows the flow for handling receive interrupts in asynchronous mode, and figure 9 shows the flow for handling receive error interrupts. For details on the settings of individual registers, see the *SH7280 Group Hardware Manual (REJ09B0393)*.

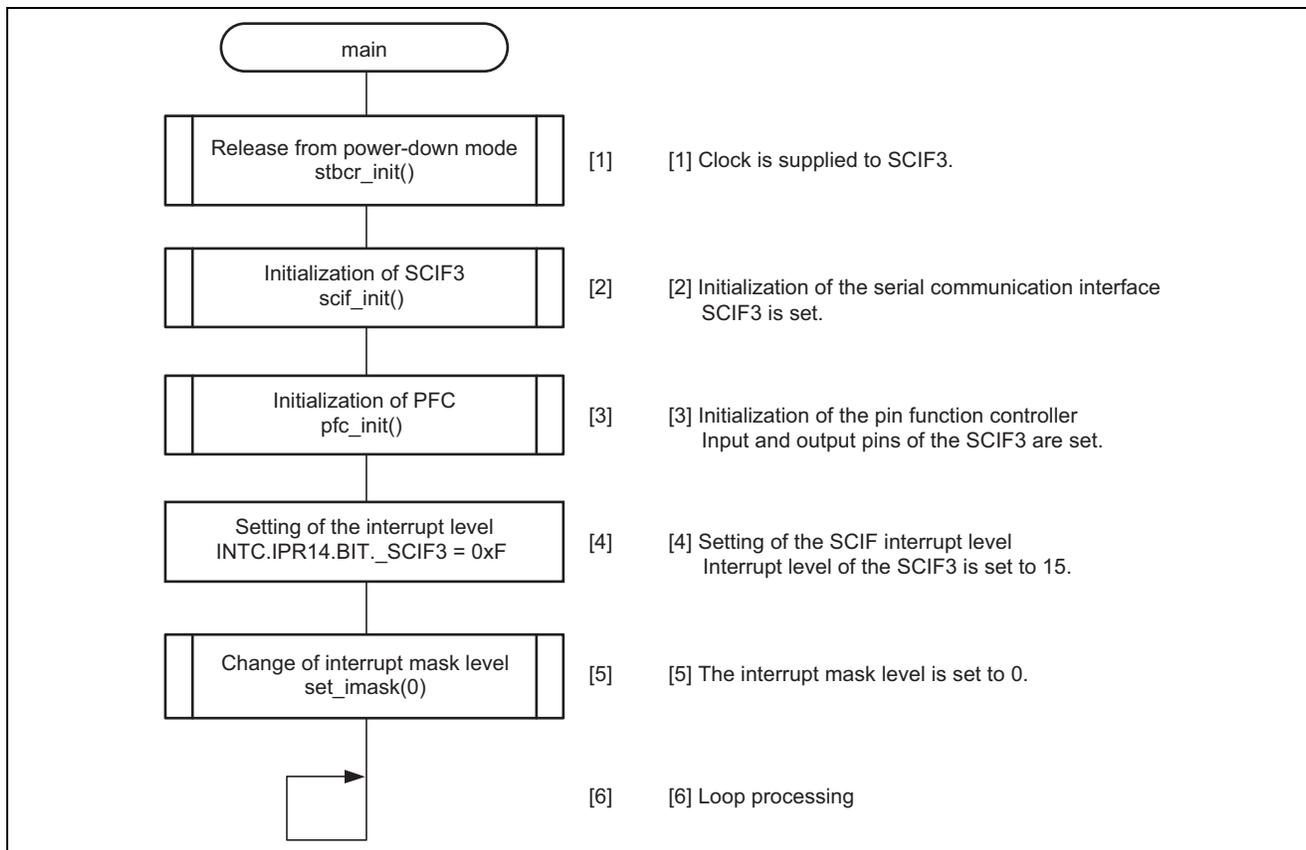
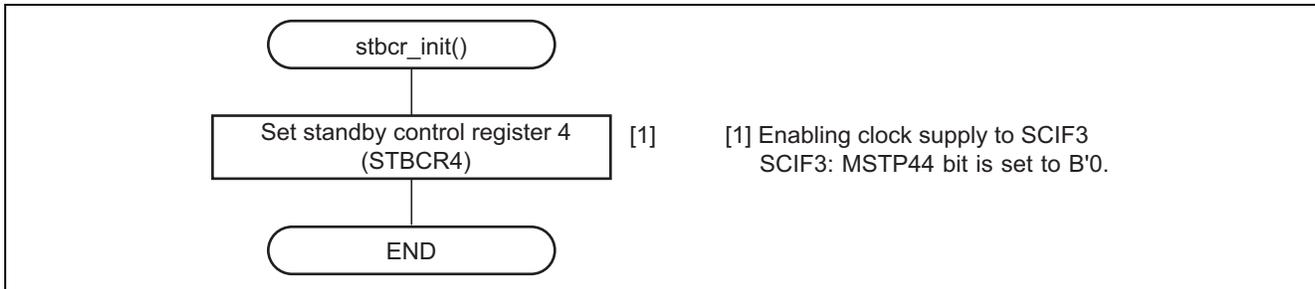
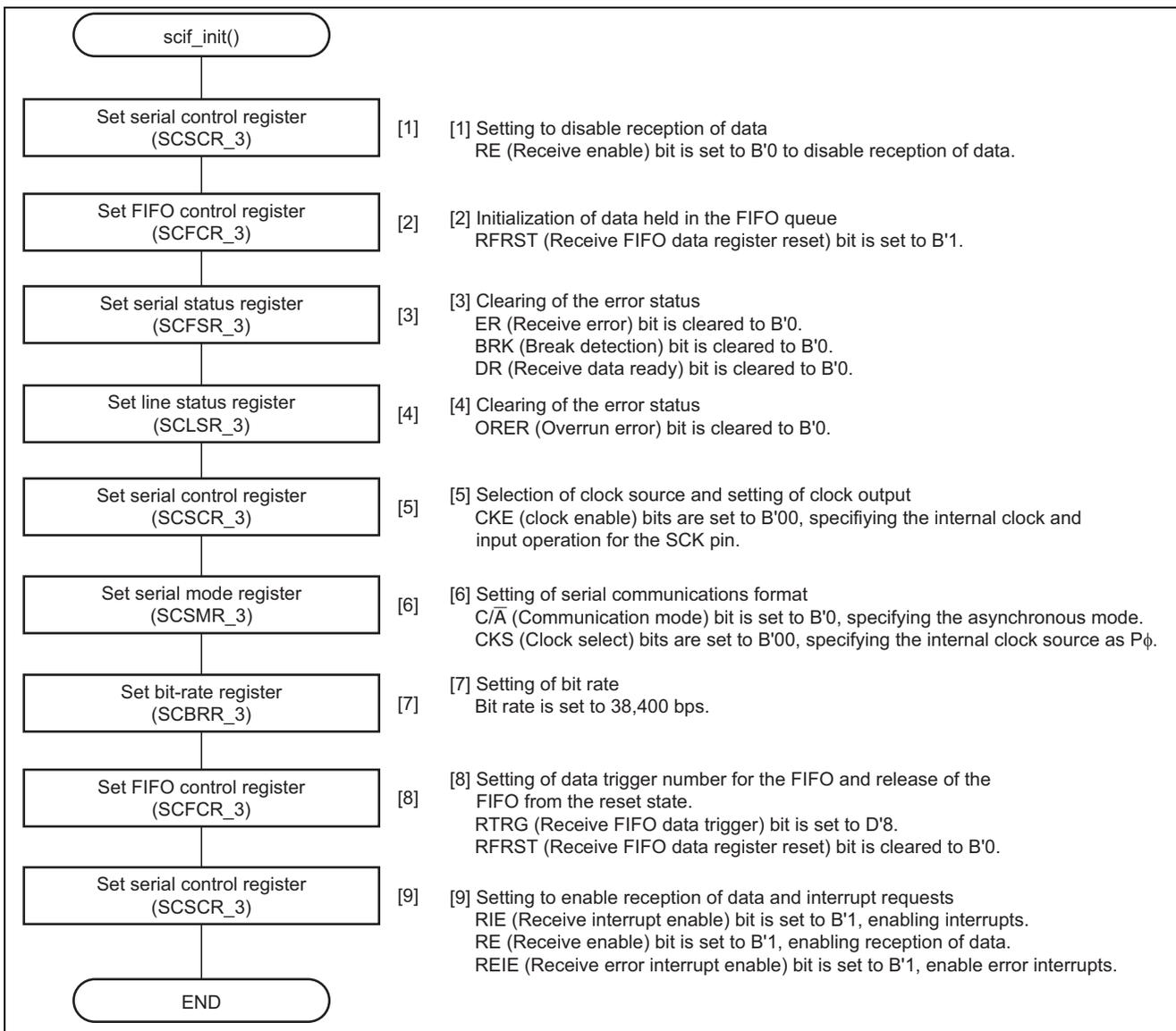


Figure 4 Flow of Processing by the Sample Program



**Figure 5 Flow of Settings for Release from Module-Standby Mode**



**Figure 6 Flow for Initialization of Data Reception in Asynchronous Mode**

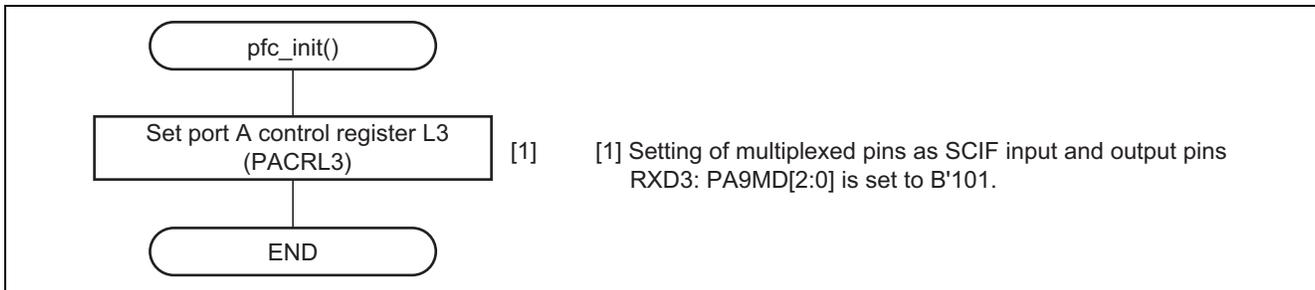


Figure 7 Flow for Setting up the Pin Function Controller

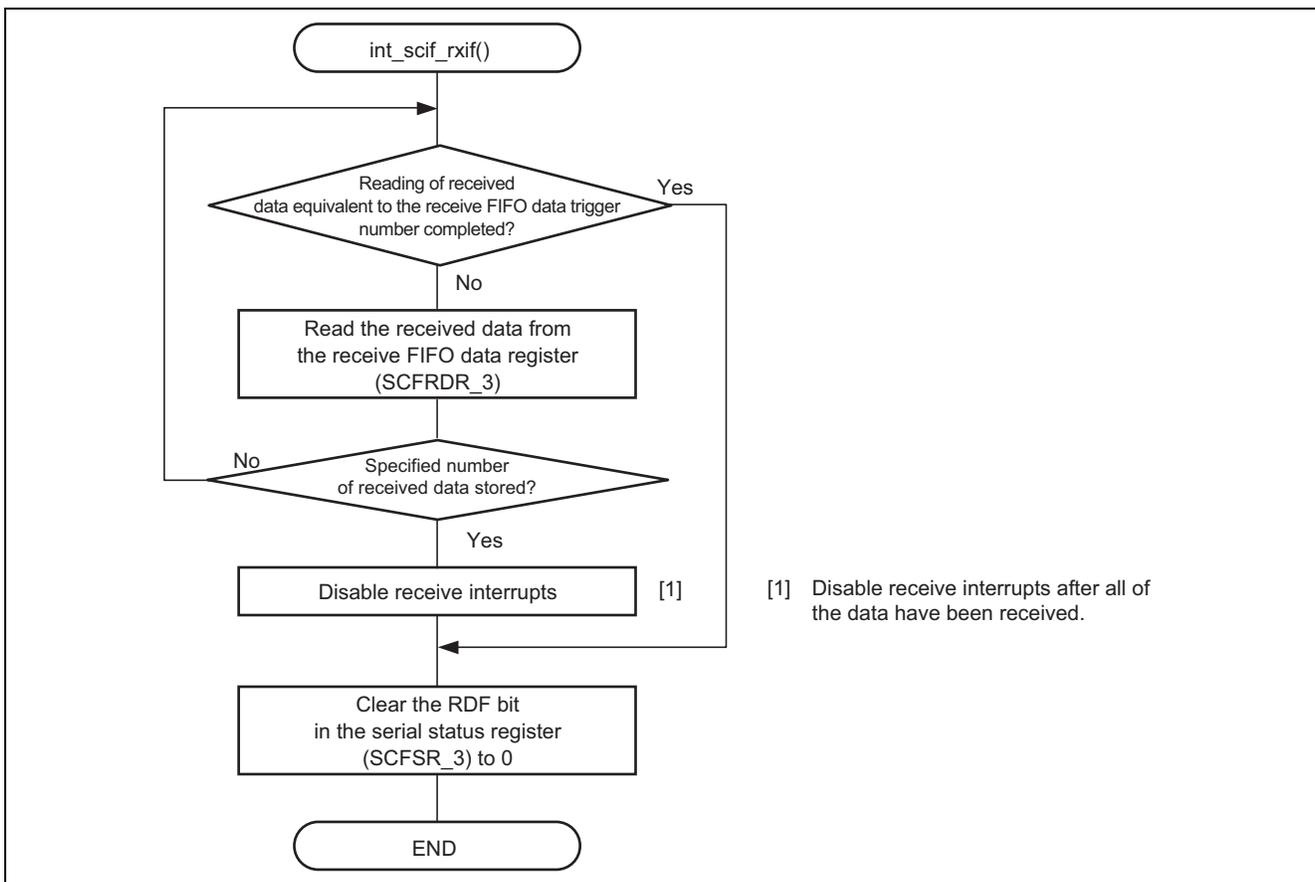


Figure 8 Flow for Handling of Receive Interrupts in Asynchronous Mode

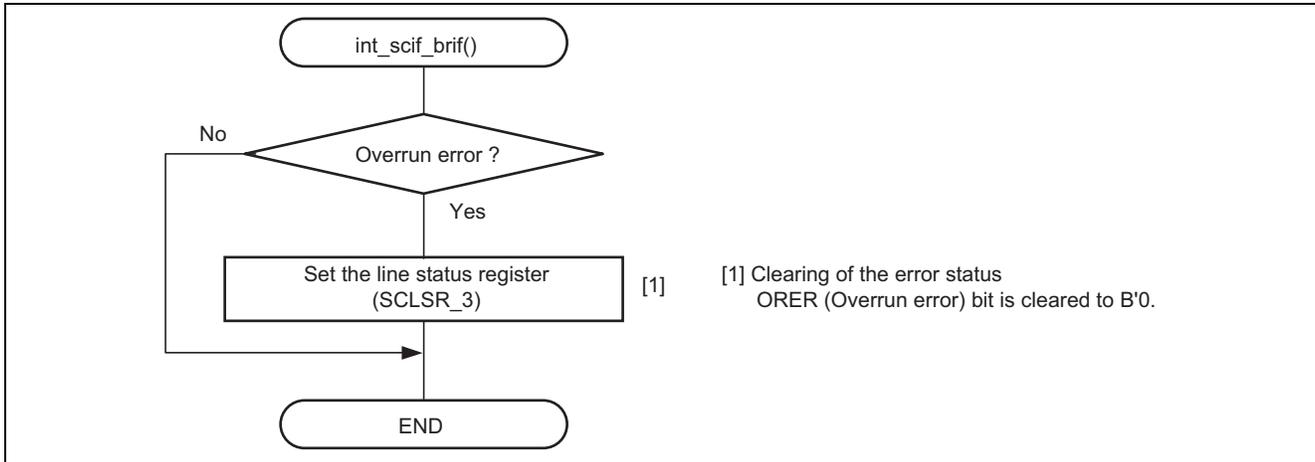


Figure 9 Flow for Handling of Receive Error Interrupts in Asynchronous Mode

## 2.4 Procedure for Processing by the Sample Program

In this sample program, character strings are received after initialization of SCIF3 in asynchronous mode.

### 2.4.1 Clock Pulse Generator (CPG)

Table 3 gives settings for the register of the clock pulse generator in the sample program.

**Table 3 Settings for Register in Clock Pulse Generator**

Register Name	Address	Setting	Description
Frequency control register (FRQCR)	H'FFFE 0010	H'0101	STC [2:0] = B'001: × 1/2 (B $\phi$ ) IFC [2:0] = B'000: × 1 (I $\phi$ ) PFC [2:0] = B'001: × 1/2 (P $\phi$ )
MTU2S clock frequency control register (MCLKCR)	H'FFFE 0410	H'41	MSSCS [1:0] = B'01: PLL output clock MSDIVS [1:0] = B'01: × 1/2 (M $\phi$ )
AD clock frequency control register (ACLKCR)	H'FFFE 0414	H'41	ASSCS [1:0] = B'01: PLL output clock ASDIVS [1:0] = B'01: × 1/2 (A $\phi$ )

### 2.4.2 Low Power Consumption Mode

Table 4 gives settings for the standby control register in the sample program.

**Table 4 Settings for Standby Control Register**

Register Name	Address	Setting	Description
Standby control register 4 (STBCR4)	H'FFFE 040C	H'E4	MSTP44 = B'0: SCIF3 operates

### 2.4.3 Interrupt Controller (INTC)

Table 5 gives settings for the register of the interrupt controller in the sample program.

**Table 5 Settings for Register of Interrupt Controller**

Register Name	Address	Setting	Description
Interrupt priority register 14 (IPR14)	H'FFFE 0C10	H'000F	IPR14 [3:0] = H'F: SCIF3 is at a level 15

Note: The interrupt priority levels of RXI3 and TXI3 are in accord with the order of the corresponding address offsets in the vector table. For details on interrupt priority levels, see Interrupt Exception Handling Vector Table and Priority in the section on interrupt controller in the *SH7280 Group Hardware Manual (REJ09B0393)*.

### 2.4.4 Pin Function Controller (PFC)

Table 6 gives settings for the register of the pin function controller in the sample program.

**Table 6 Settings for Register of Pin Function Controller**

Register Name	Address	Setting	Description
Port A control register L3 (PACRL3)	H'FFFE 3812	H'0050	PA9MD [2:0] = B'101: RXD3 input

### 2.4.5 Serial Communications Interface with FIFO

Table 7 gives settings for the registers of the SCIF in the sample program.

**Table 7 Settings for SCIF Register**

Register Name	Address	Setting	Description
Serial mode register_3 (SCSMR_3)	H'FFFE 9800	H'0000	C/ $\bar{A}$ = B'0: Asynchronous mode CHR = B'0: 8-bit data PE = B'0: Disables adding and checking of parity bits STOP = B'0: 1 stop bit CKS [1:0] = B'00: P $\phi$ clock
Bit rate register_3 (SCBRR_3)	H'FFFE 9804	D'124	Asynchronous mode Bit rate: 38400 (bit/s) * <sup>1</sup>
Serial control register_3 (SCSCR_3)	H'FFFE 9808	H'0000	Initialization RIE = B'0: Disables receive-FIFO-data-full interrupt (RXI), receive-error-interrupt (ERI) requests RE = B'0: Disables reception of data
		H'0050	At the time of setting Asynchronous mode CKE [1:0] = B'0: Internal clock, SCK pin is used as an input pin When receiving operation is enabled RIE = B'1: Enables receive-FIFO-data-full interrupt (RXI) request RE = B'1: Enables reception of data
Serial status register_3 (SCFSR_3)	H'FFFE 9810	H'0000	At the time of setting All the flags are cleared.

Note: 1. For details on bit rate settings, see the table of bit rates and SCBRR settings in the section on the serial communication interface with FIFO in the *SH7280 Group Hardware Manual (REJ09B0393)*.

### 3. Documents for Reference

- Software Manual  
SH-2A, SH2A-FPU Software Manual (REJ09B0051)  
The most up-to-date version of this document is available on the Renesas Technology Website.
- Hardware Manual  
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## Revision Record

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